



# Power MOSFETS

## DATASHEET

**LM60400DAQ8A**

Dual N-Channel  
Enhancement Mode MOSFET

- [Leadpower-semiconductor Corp., Ltd](#)
- [sales@leadpower-semi.com](mailto:sales@leadpower-semi.com)
- (03) 6577339 FAX : (03) 6577229
- [www.leadpower-semi.com](http://www.leadpower-semi.com)



Quality Management Systems  
ISO 9001:2015 Certificate

## Dual N-Channel Enhancement Mode MOSFET

### Pin Description

SOP-8L (TOP view)		Symbol 	<b>Symbol</b>	Dual N-Channel	Unit
			$V_{DSS}$	<b>60</b>	<b>V</b>
			$R_{DS(ON)-Max}$	<b>39</b>	<b>mΩ</b>
			$I_D$	<b>4.8</b>	<b>A</b>

### Feature

- Dual N Channel MOSFET
- Fast switching speed
- ROHS Compliant & Halogen-Free
- Reliable and Rugged

### Applications

- DC-DC Converters
- White LED boost converters

### Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM60400DAQ8A	SOP-8L	Tape & Reel	3000 / Tape & Reel	60400 □□□□□□

Note : □□□□□□ = Lot Code

### Absolute Maximum Ratings ( $T_J=25^\circ C$ Unless Otherwise Noted)

Symbol	Parameter	Dual N-Channel	Unit
$V_{DSS}$	Drain-Source Voltage	60	
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	V
$T_J$	Maximum Junction Temperature	150	$^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$I_{DM}^{\textcircled{1}}$	Pulse Drain Current Tested	$T_A=25^\circ C$	A
$I_D$	Continuous Drain Current	$T_A=25^\circ C$	4.8
		$T_A=70^\circ C$	3.8
$P_D$	Maximum Power Dissipation	$T_A=25^\circ C$	1.7
		$T_A=70^\circ C$	1.1
$I_{AS}^{\textcircled{2}}$	Avalanche Current, Single pulse	L=0.1mH	A
$E_{AS}^{\textcircled{2}}$	Avalanche Energy, Single pulse	L=0.1mH	mJ

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}^{\textcircled{3}}$	Thermal Resistance-Junction to Ambient	$t \leq 10s$	$^\circ C/W$
		Steady State	74

Note ① : Max. current is limited by junction temperature.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

# LM60400DAQ8A

## N -Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{DS}}=250\mu\text{A}$	60	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=48\text{V}$ , $V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{DS}}=250\mu\text{A}$	1.2	1.8	2.5	V
$I_{\text{GSS}}$	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	$\text{nA}$
$R_{\text{DS(ON)}}^{\text{(4)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$ , $I_{\text{DS}}=10\text{A}$	-	33	39	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_{\text{DS}}=8\text{A}$	-	36	47	
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=5\text{V}$ , $I_{\text{DS}}=10\text{A}$	-	10	-	S
<b>Dynamic Characteristics <sup>(5)</sup></b>						
$R_{\text{G}}$	Gate Resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , Freq.=1MHz	-	3.8	-	$\Omega$
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=30\text{V}$ , Freq.=1MHz	-	1108	-	$\text{pF}$
$C_{\text{oss}}$	Output Capacitance		-	65	-	
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	44	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=30\text{V}$ , $I_{\text{D}}=1\text{A}$ , $R_{\text{GEN}}=6\Omega$	-	6	-	$\text{nS}$
$t_{\text{r}}$	Turn-on Rise Time		-	21	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	44	-	
$t_{\text{f}}$	Turn-off Fall Time		-	20	-	
$Q_{\text{g}}$	Total Gate Charge	$V_{\text{GS}}=4.5\text{V}$ , $V_{\text{DS}}=30\text{V}$ $I_{\text{D}}=10\text{A}$	-	13	-	$\text{nC}$
$Q_{\text{g}}$	Total Gate Charge	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=30\text{V}$ , $I_{\text{D}}=10\text{A}$	-	26	-	
$Q_{\text{gs}}$	Gate-Source Charge		-	3.9	-	
$Q_{\text{gd}}$	Gate-Drain Charge		-	4.8	-	
<b>Source-Drain Characteristics</b>						
$V_{\text{SD}}^{\text{(4)}}$	Diode Forward Voltage	$I_{\text{SD}}=1\text{A}$ , $V_{\text{GS}}=0\text{V}$	-	0.75	1.1	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_{\text{F}}=1\text{A}$ , $V_{\text{GS}}=0\text{V}$	-	19.6	-	$\text{nS}$
$Q_{\text{rr}}$	Reverse Recovery Charge	$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	15.1	-	$\text{nC}$

Note ④ : Pulse test (pulse width $\leq 300\text{us}$ , duty cycle $\leq 2\%$ ).

Note ⑤ : Guaranteed by design, not subject to production testing.

## N -Channel Typical Characteristics

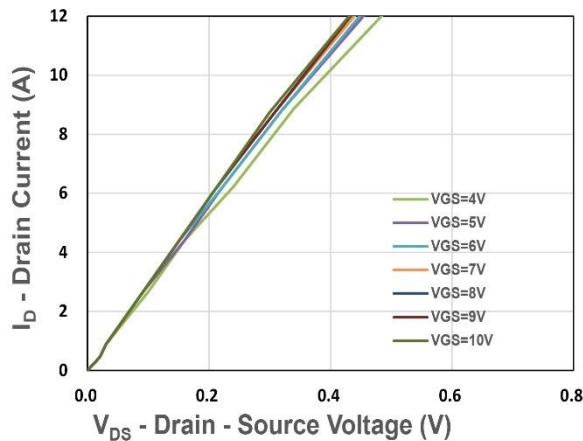


Figure 1. Output Characteristics

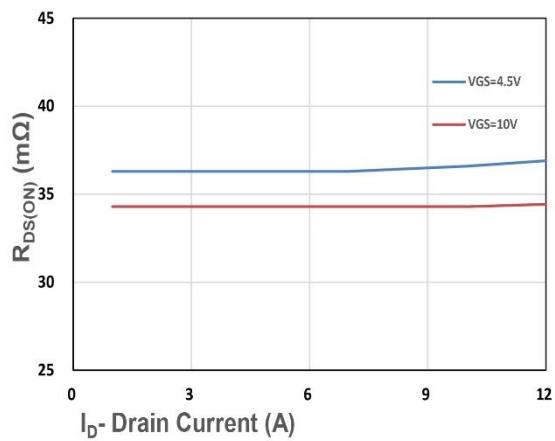


Figure 2. On-Resistance vs. ID

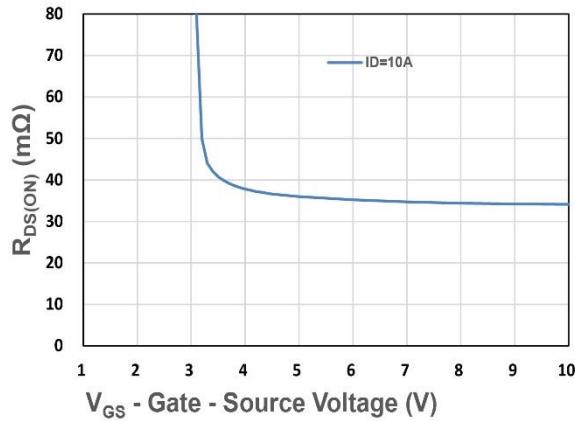


Figure 3. On-Resistance vs. VGS

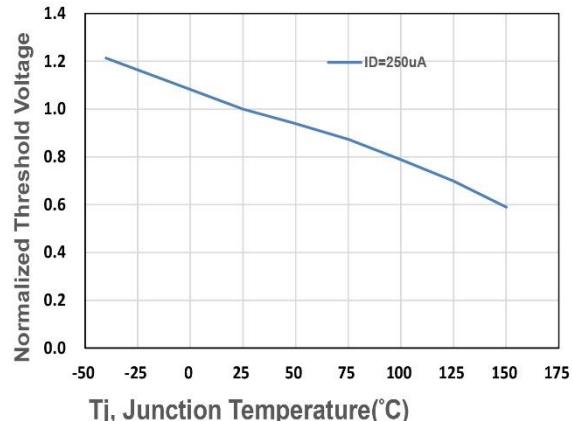


Figure 4. Gate Threshold Voltage

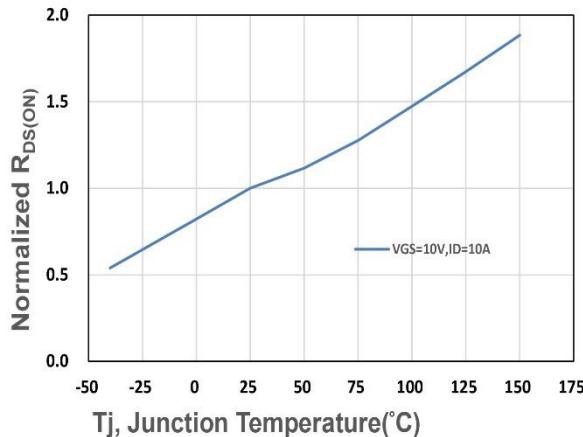


Figure 5. Drain-Source On Resistance

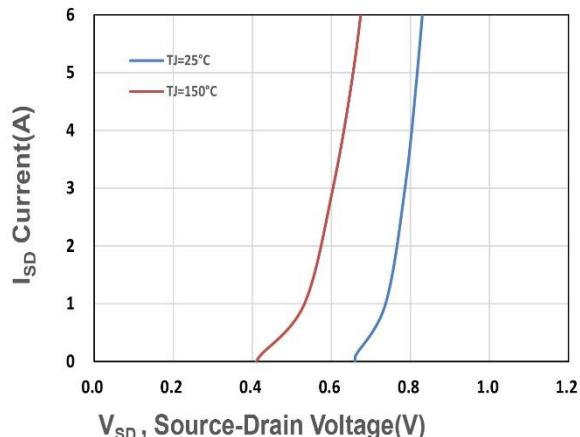


Figure 6. Source-Drain Diode Forward

# LM60400DAQ8A

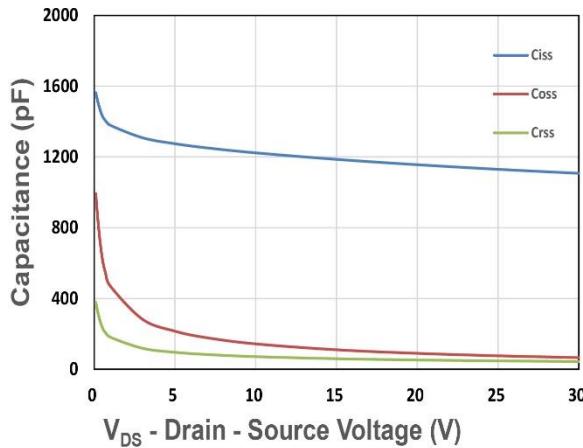


Figure 7. Capacitance

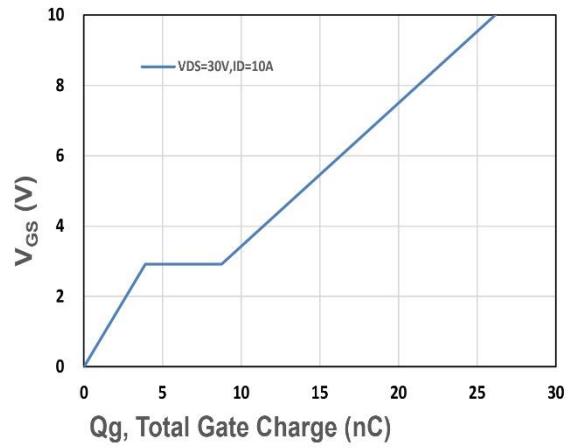


Figure 8. Gate Charge Characteristics

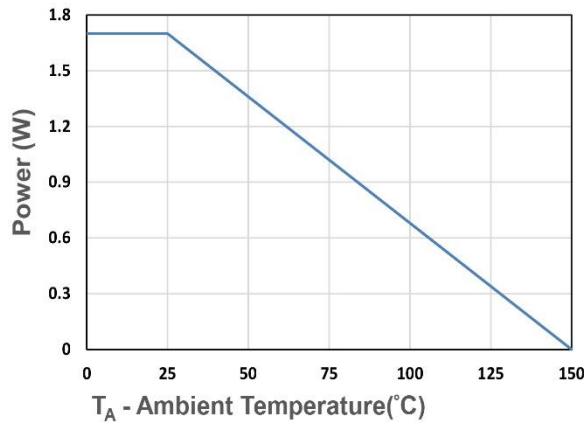


Figure 9. Power Dissipation

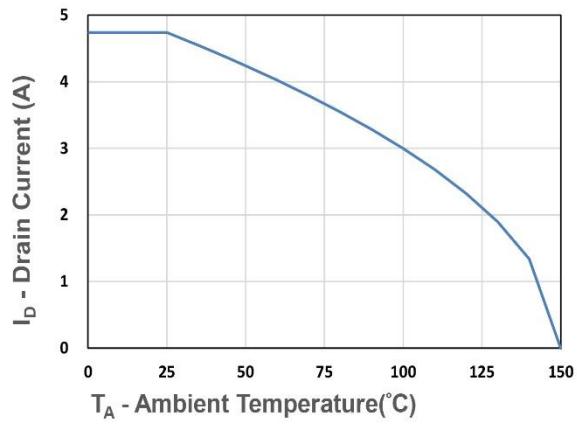


Figure 10. Drain Current

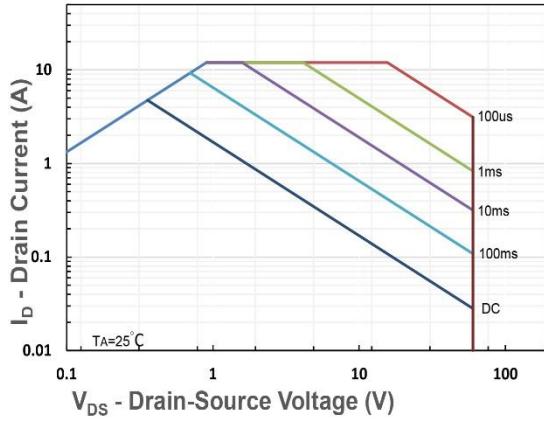


Figure 11. Safe Operating Area

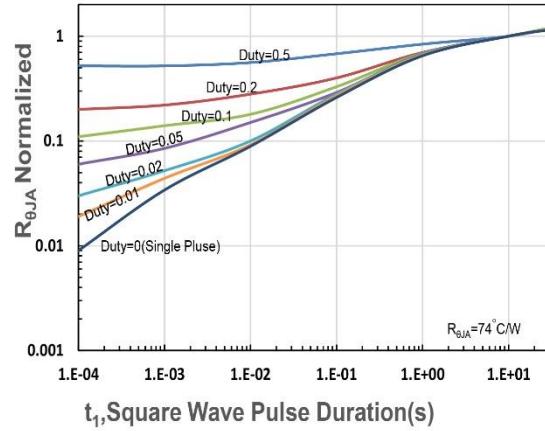


Figure 12. R<sub>θJA</sub> Transient Thermal Impedance